



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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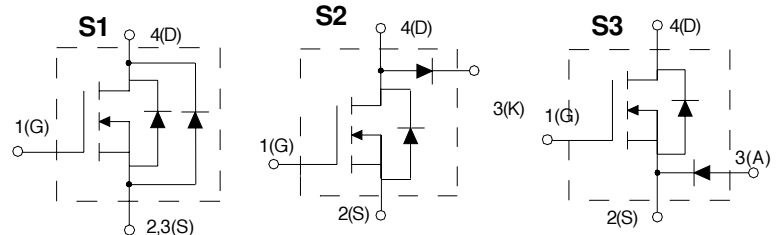


HiPerFET™ Power MOSFETs with Schottky Diodes

IXFN 100N10S1
IXFN 100N10S2
IXFN 100N10S3

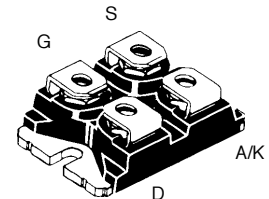
$V_{DSS} = 100 \text{ V}$
 $I_{D25} = 100 \text{ A}$
 $R_{DS(on)} = 15 \text{ m}\Omega$

Parallel, Buck & Boost Configurations
for SMPS, PFC & Motor Control Circuits



	Symbol	Test Conditions	Maximum Ratings	
HiPerFET MOSFET	V_{DSS}	$T_J = 25^\circ\text{C}$ to 150°C	100	V
	V_{DGR}	$T_J = 25^\circ\text{C}$ to 150°C ; $R_{GS} = 1 \text{ M}\Omega$	100	V
	V_{GS}	Continuous	± 20	V
	V_{GSM}	Transient	± 30	V
	I_{D25}	$T_C = 25^\circ\text{C}$	100	A
	I_{DM}	$T_C = 25^\circ\text{C}$, pulse width limited by max. T_{JM}	400	A
	I_{AR}	$T_C = 25^\circ\text{C}$	100	A
	E_{AR}	Repetitive	45	mJ
	dv/dt	$I_S \leq I_{DM}$, $-di/dt \leq 100 \text{ A}/\mu\text{s}$, $V_{DD} \leq V_{DSS}$, $T_J \leq 150^\circ\text{C}$, $R_G = 2 \Omega$	5	V/ns
	P_D	$T_C = 25^\circ\text{C}$	360	W
Diode	V_{RRM}		100	V
	I_{RMS}		100	A
	I_{FAVM}	$T_C = 105^\circ\text{C}$; rectangular, $d = 0.5$	60	A
	I_{FRM}	$t_p < 10 \mu\text{s}$; pulse width limited by T_J	700	A
	$(dv/dt)_{CR}$		1	V/ns
	P_D	$T_C = 25^\circ\text{C}$	150	W
Case	T_J		-40 ... +150	$^\circ\text{C}$
	T_{JM}		150	$^\circ\text{C}$
	T_{stg}		-40 ... +150	$^\circ\text{C}$
	V_{ISOL}	50/60 Hz, RMS $I_{ISOL} \leq 1 \text{ mA}$ $t = 1 \text{ min}$	2500 3000	V~ V~
	M_d	Mounting torque Terminal connection torque (M4)	1.5/13 1.5/13	Nm/lb.in. Nm/lb.in.
	Weight		30	g

miniBLOC, SOT-227 B
E153432



S = Source
G = Gate
D = Drain
A = Anode
K = Cathode

Features

- Popular Buck & Boost circuit topologies
- Low V_F Schottky diode with very small switching losses
- International standard package miniBLOC SOT-227 B
- Aluminium nitride isolation
 - high power dissipation
- Isolation voltage 3000 V~
- Low $R_{DS(on)}$ HDMOS™ process
- Rugged polysilicon gate cell structure
- Low drain-to-case capacitance (<60 pF)
 - reduced RFI

Applications

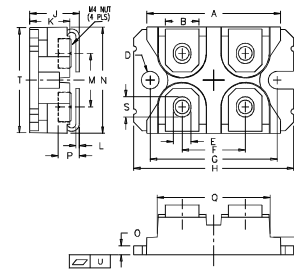
- SMPS, power factor controls and buck regulators
- DC servo and robotic drives
- DC choppers
- Switch reluctance motor controls

Advantages

- Easy to mount with 2 screws
- Space savings
- Tightly coupled Schottky diode

Symbol	Test Conditions	Characteristic Values (T _J = 25°C; unless otherwise specified)			
				min.	typ.
V _{DSS}	V _{GS} = 0 V; I _D = 3 mA	S1	100		V
	V _{GS} = 0 V; I _D = 250 μA	S2/S3	100		V
V _{GS(th)}	V _{DS} = V _{GS} ; I _D = 4 mA		2		4 V
I _{GSS}	V _{GS} = ±20 V _{DC} ; V _{DS} = 0				±100 nA
I _{DSS}	V _{DS} = V _{DSS} ; V _{GS} = 0 V T _J = 125°C	S1			2 mA
		S2/S3			25 μA
		S1			20 mA
		S2/S3			1 mA
R _{DS(on)}	V _{GS} = 10 V; I _D = 0.5 I _{D25} ; Note 1				15 mΩ
g _{fs}	V _{DS} = 10 V; I _D = 0.5 I _{D25} ; pulse test		30	45	S
C _{iss}	V _{GS} = 0 V; V _{DS} = 25 V; f = 1 MHz			4500	pF
C _{oss}		S1		1900	pF
		S2/S3		1600	pF
C _{rss}					870
t _{d(on)}	V _{GS} = 10 V; V _{DS} = 0.5 V _{DSS} ; I _D = 0.5 I _{D25} R _G = 1.5 Ω (External)			30	ns
t _r				70	ns
t _{d(off)}				100	ns
t _f				30	ns
Q _{g(on)}	V _{GS} = 10 V; V _{DS} = 0.5 V _{DSS} ; I _D = 0.5 I _{D25}			180	nC
Q _{gs}				36	nC
Q _{gd}				95	nC
V _{SD}	I _F = 100A; V _{GS} = 0 V; Note 1 (S2, S3)				1.5 V
t _{rr}	I _F = 25 A; -di/dt = 100 A/μs; V _R = 25 V				200 ns
Q _{RM}				0.8	μC
I _{RM}				6	A
R _{thJC}					0.35 K/W
R _{thCK}				0.05	K/W

miniBLOC, SOT-227 B



M4 screws (4x) supplied

Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	31.50	31.88	1.240	1.255
B	7.80	8.20	0.307	0.323
C	4.09	4.29	0.161	0.169
D	4.09	4.29	0.161	0.169
E	4.09	4.29	0.161	0.169
F	14.91	15.11	0.587	0.595
G	30.12	30.30	1.186	1.193
H	38.00	38.23	1.496	1.505
J	11.68	12.22	0.460	0.481
K	8.92	9.60	0.351	0.378
L	0.76	0.84	0.030	0.033
M	12.60	12.85	0.496	0.506
N	25.15	25.42	0.990	1.001
O	1.98	2.13	0.078	0.084
P	4.95	5.97	0.195	0.235
Q	26.54	26.90	1.045	1.059
R	3.94	4.42	0.155	0.174
S	4.72	4.85	0.186	0.191
T	24.59	25.07	0.968	0.987
U	-0.05	0.1	-0.002	0.004

Schottky Diode

Characteristic Values

($T_J = 25^\circ\text{C}$, unless otherwise specified)

Symbol	Test Conditions	min.	typ.	max.
I_R	$V_R = V_{RRM}$			2 mA
	$T_J = 125^\circ\text{C}; V_R = V_{RRM}$			20 mA
V_F	$I_F = 60\text{ A}; V_{GS} = 0\text{ V}; \text{Note 1}$			0.86 V
	$I_F = 60\text{ A}; V_{GS} = 0\text{ V}$			0.73 V
	$I_F = 120\text{ A}$			0.93 V
R_{thJC}				0.8 K/W
R_{thJK}			0.1	K/W

IXYS reserves the right to change limits, test conditions, and dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents:

4,835,592 4,881,106 5,017,508 5,049,961 5,187,117 5,486,715
4,850,072 4,931,844 5,034,796 5,063,307 5,237,481 5,381,025